



ABSTRACT

This document describes the known exceptions to the functional specifications (advisories).

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1 Functional Advisories

Advisories that affect the device's operation, function, or parametrics.

✓ The check mark indicates that the issue is present in the specified revision.

Errata Number	Rev B
ESP1	✓
ESP4	✓
FLL3	✓
TA12	✓
TA16	✓
TA21	✓
TAB22	✓
US15	✓
WDG2	✓

2 Preprogrammed Software Advisories

Advisories that affect factory-programmed software.

✓ The check mark indicates that the issue is present in the specified revision.

The device does not have any errata for this category.

3 Debug Only Advisories

Advisories that affect only debug operation.

✓ The check mark indicates that the issue is present in the specified revision.

Errata Number	Rev B
EEM20	✓

4 Fixed by Compiler Advisories

Advisories that are resolved by compiler workaround. Refer to each advisory for the IDE and compiler versions with a workaround.

✓ The check mark indicates that the issue is present in the specified revision.

Errata Number	Rev B
CPU4	✓

Refer to the following MSP430 compiler documentation for more details about the CPU bugs workarounds.

TI MSP430 Compiler Tools (Code Composer Studio IDE)

- [MSP430 Optimizing C/C++ Compiler](#): Check the --silicon_errata option
- [MSP430 Assembly Language Tools](#)

MSP430 GNU Compiler (MSP430-GCC)

- [MSP430 GCC Options](#): Check -msilicon-errata= and -msilicon-errata-warn= options
- [MSP430 GCC User's Guide](#)

IAR Embedded Workbench

- [IAR workarounds for msp430 hardware issues](#)

5 Nomenclature, Package Symbolization, and Revision Identification

The revision of the device can be identified by the revision letter on the [Package Markings](#) or by the [HW_ID](#) located inside the TLV structure of the device.

5.1 Device Nomenclature

To designate the stages in the product development cycle, TI assigns prefixes to the part numbers of all MSP MCU devices. Each MSP MCU commercial family member has one of two prefixes: MSP or XMS. These prefixes represent evolutionary stages of product development from engineering prototypes (XMS) through fully qualified production devices (MSP).

XMS – Experimental device that is not necessarily representative of the final device's electrical specifications

MSP – Fully qualified production device

Support tool naming prefixes:

X: Development-support product that has not yet completed Texas Instruments internal qualification testing.

null: Fully-qualified development-support product.

XMS devices and X development-support tools are shipped against the following disclaimer:

"Developmental product is intended for internal evaluation purposes."

MSP devices have been characterized fully, and the quality and reliability of the device have been demonstrated fully. TI's standard warranty applies.

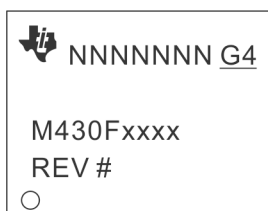
Predictions show that prototype devices (XMS) have a greater failure rate than the standard production devices. TI recommends that these devices not be used in any production system because their expected end-use failure rate still is undefined. Only qualified production devices are to be used.

TI device nomenclature also includes a suffix with the device family name. This suffix indicates the temperature range, package type, and distribution format.

5.2 Package Markings

PM64

LQFP (PM), 64 Pin



= Die revision
○ = Pin 1 location
N = Lot trace code

5.3 Memory-Mapped Hardware Revision (TLV Structure)

This device does not support reading the hardware revision from memory.

Further guidance on how to locate the TLV structure and read out the HW_ID can be found in the device User's Guide.

6 Advisory Descriptions

CPU4

CPU Module

Category

Compiler-Fixed

Function

PUSH #4, PUSH #8

Description

The single operand instruction PUSH cannot use the internal constants (CG) 4 and 8. The other internal constants (0, 1, 2, -1) can be used. The number of clock cycles is different:

PUSH #CG uses address mode 00, requiring 3 cycles, 1 word instruction

PUSH #4/#8 uses address mode 11, requiring 5 cycles, 2 word instruction

Workaround

Refer to the table below for compiler-specific fix implementation information.

IDE/Compiler	Version Number	Notes
IAR Embedded Workbench	IAR EW430 v2.x until v6.20	User is required to add the compiler flag option below. --hw_workaround=CPU4
IAR Embedded Workbench	IAR EW430 v6.20 or later	Workaround is automatically enabled
TI MSP430 Compiler Tools (Code Composer Studio)	v1.1 or later	
MSP430 GNU Compiler (MSP430-GCC)	MSP430-GCC 4.9 build 167 or later	

EEM20

EEM Module

Category

Debug

Function

Debugger might clear interrupt flags

Description

During debugging read-sensitive interrupt flags might be cleared as soon as the debugger stops. This is valid in both single-stepping and free run modes.

Workaround

None.

ESP1

ESP Module

Category

Functional

Function

Suspending the ESP430CE1

Description

Suspending the ESP430 may create an invalid interrupt which can lead to a reset-like behavior of the module.

Workaround

Set the bit 0x08 together with the ESPSUSP bit:

```
bis.w #08h+ESPSUSP, &ESPCTL
```

This bit also must be cleared when the suspend mode is exited.

```
bic.w #08h+ESPSUSP, &ESPCTL
```

NOTE:

- After suspending the ESP430CE1 it can take up to 9 MCLK clock cycles before the CPU can access the SD16 registers.

- An interrupt service routine for the SD16 is required.

```

// Shut down ESP (set Embedded Signal Processing into
// "Suspend" mode)
// ensure that it is not in measurement or calibration mode,
ESPCTL |= 0x08 + ESPSUSP;
// Set ESP into Suspend Mode
// incl. Bug Fix for Suspend Mode
// wait 9 clocks until proper access to the SD16 is possible
__delay_cycles(9);

MBCTL &= ~(IN0IFG + IN0IE);
// Clear any Pending MB interrupt and disable
// ESP interrupt
SD16CTL &= ~SD16REFON; // Switch Reference off
    
```

ESP4

ESP Module

Category

Functional

Function

Suspending the ESP430 activity

Description

Due to timing violations between the ESP CPU and the MSP430 CPU, the SD16 converters are not switched off correctly if the ESP CPU is set into suspend mode immediately after the ESP CPU is checked for idle mode. This leads to a higher current consumption in low-power modes.

Workaround

Implement an additional wait loop of 16 clock cycles between checking the ESP for idle mode and set the ESP CPU into suspend mode.

```

while ((RET0 & 0x8000) != 0); // Wait for Idle mode
// wait 16 clocks to exclude timing violations between MSP430 CPU
// and ESP CPU
__NOP();__NOP();__NOP();__NOP();__NOP();__NOP();__NOP();__NOP();__NOP();--
__NOP();__NOP();__NOP();__NOP();__NOP();__NOP();__NOP();
// Shut down ESP (set Embedded Signal Processing into "Suspend" mode)
// ensure that it is not in measurement or calibration mode,
if ((RET0 & 0x8000) == 0)
{
ESPCTL |= 0x08 + ESPSUSP; // Set ESP into Suspend Mode
// incl. Bug Fix for Suspend Mode
}
    
```

FLL3

FLL Module

Category

Functional

Function

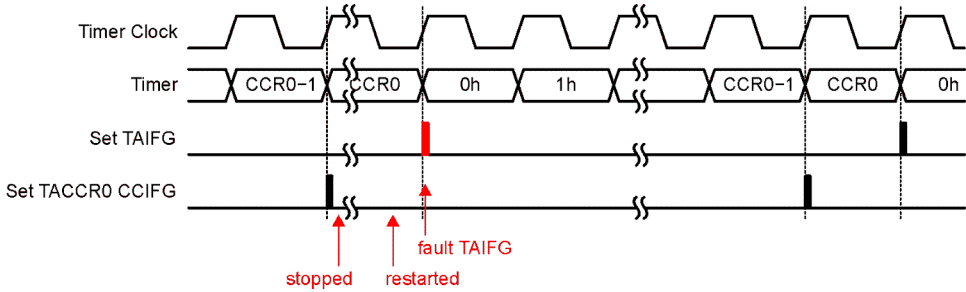
FLLDx = 11 for /8 may generate an unstable MCLK frequency

Description

When setting the FLL to higher frequencies using FLLDx = 11 (/8) the output frequency of the FLL may have a larger frequency variation (e.g. averaged over 2sec) as well as a lower average output frequency than expected when compared to the other FLLDx bit settings.

Workaround

None

TA12	TA Module
Category	Functional
Function	Interrupt is lost (slow ACLK)
Description	<p>Timer_A counter is running with slow clock (external TACLK or ACLK) compared to MCLK. The compare mode is selected for the capture/compare channel and the CCRx register is incremented by one with the occurring compare interrupt (if TAR = CCRx). Due to the fast MCLK the CCRx register increment (CCRx = CCRx+1) happens before the Timer_A counter has incremented again. Therefore the next compare interrupt should happen at once with the next Timer_A counter increment (if TAR = CCRx + 1). This interrupt gets lost.</p>
Workaround	<p>Switch capture/compare mode to capture mode before the CCRx register increment. Switch back to compare mode afterwards.</p>
TA16	TA Module
Category	Functional
Function	First increment of TAR erroneous when IDx > 00
Description	<p>The first increment of TAR after any timer clear event (POR/TACLR) happens immediately following the first positive edge of the selected clock source (INCLK, SMCLK, ACLK or TACLK). This is independent of the clock input divider settings (ID0, ID1). All following TAR increments are performed correctly with the selected IDx settings.</p>
Workaround	None
TA21	TA Module
Category	Functional
Function	TAIFG Flag is erroneously set after Timer A restarts in Up Mode
Description	<p>In Up Mode, the TAIFG flag should only be set when the timer counts from TACCR0 to zero. However, if the Timer A is stopped at TAR = TACCR0, then cleared (TAR=0) by setting the TACLR bit, and finally restarted in Up Mode, the next rising edge of the TACLK will erroneously set the TAIFG flag.</p>
	 <p>The diagram shows four signals over time: Timer Clock, Timer, Set TAIFG, and Set TACCR0 CCIFG. The timer value starts at CCR0-1, reaches CCR0, and then 0h. It then jumps to 1h and returns to CCR0-1, then CCR0, and finally 0h. The Set TAIFG signal is set at the rising edge of the timer when it reaches 0h. The Set TACCR0 CCIFG signal is set at the rising edge of the timer when it reaches CCR0. Red arrows indicate the timer being stopped at CCR0 and then restarted, which causes a fault TAIFG to be set.</p>
Workaround	None.
TAB22	TAB Module
Category	Functional
Function	Timer_A/Timer_B register modification after Watchdog Timer PUC

Description Unwanted modification of the Timer_A/Timer_B registers TACTL/TBCTL and TAIV/TBIV can occur when a PUC is generated by the Watchdog Timer(WDT) in Watchdog mode and any Timer_A/Timer_B counter register TACCRx/TBCCRx is incremented/decremented (Timer_A/Timer_B does not need to be running).

Workaround Initialize TACTL/TBCTL register after the reset occurs using a MOV instruction (BIS/BIC may not fully initialize the register). TAIV/TBIV is automatically cleared following this initialization.

Example code:

```
MOV.W #VAL, &TACTL
or
MOV.W #VAL, &TBCTL
```

Where, VAL=0, if Timer is not used in application otherwise, user defined per desired function.

US15 *USART Module*

Category Functional

Function UART receive with two stop bits

Description USART hardware does not detect a missing second stop bit when SPB = 1. The Framing Error Flag (FE) will not be set under this condition and erroneous data reception may occur.

Workaround None (Configure USART for a single stop bit, SPB = 0)

WDG2 *WDG Module*

Category Functional

Function Incorrectly accessing a flash control register

Description If a key violation is caused by incorrectly accessing a flash control register, the watchdog interrupt flag is set in addition to the expected PUC.

Workaround None

7 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from May 29, 2018 to May 11, 2021	Page
<ul style="list-style-type: none">Changed the document format and structure; updated the numbering format for tables, figures, and cross references throughout the document.....	4

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